

IJFCOB28A Data Sheet



India's first LED Chip – Complying International Quality and Lighting Standards.

Description:

Indo Japan's F - COB series products use high quality silica gel packages with Aluminium Oxide Substrate which improves the heat dissipation, thus enhancing the performance and reliability of LED Chips.

F - COB series has low power consumption, high CRI, wide beam angle, long product life and less heat emission compared to traditional COBs which makes this series suitable for all forms of lighting applications.

Features:

- RoHS & CE Compliant
- Pb free
- Size : 13.5mm x 13.5mm x 1.6mm
- Viewing Angle : 120°
- COB LED
- High Lumen Output
- Low Power Consumption

Applications:

- Spot Light
- Down Light
- Façade Light
- Street Light
- Flood Light
- Automobile Headlamp

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Absolute Maximum Ratings ($T_{\text{Soldering}} / T_a = 25^{\circ}\text{C}$)

Parameters	Symbol	Rating	Unit
Max Forward Current	I_f	700	mA
Peak Pules Current (Duty 1/10 @10ms)	I_{fp}	840	mA
Power Dissipation	P_d	27720	mW
Operating Temperature	T_{opr}	-40 ~ +85	$^{\circ}\text{C}$
Storage Temperature	T_{stg}	-40 ~ +100	$^{\circ}\text{C}$
Thermal Resistance (Junction / Soldering point)	$R_{th J-S}$	10	$^{\circ}\text{C}/\text{W}$
Junction Temperature	T_j	135	$^{\circ}\text{C}$
Soldering Temperature	T_{sol}	Reflow Soldering : 260 $^{\circ}\text{C}$ for 10 sec. Hand Soldering : 350 $^{\circ}\text{C}$ for 3 sec.	

Note:

1. The products are sensitive to static electricity and must be carefully taken when handling products.

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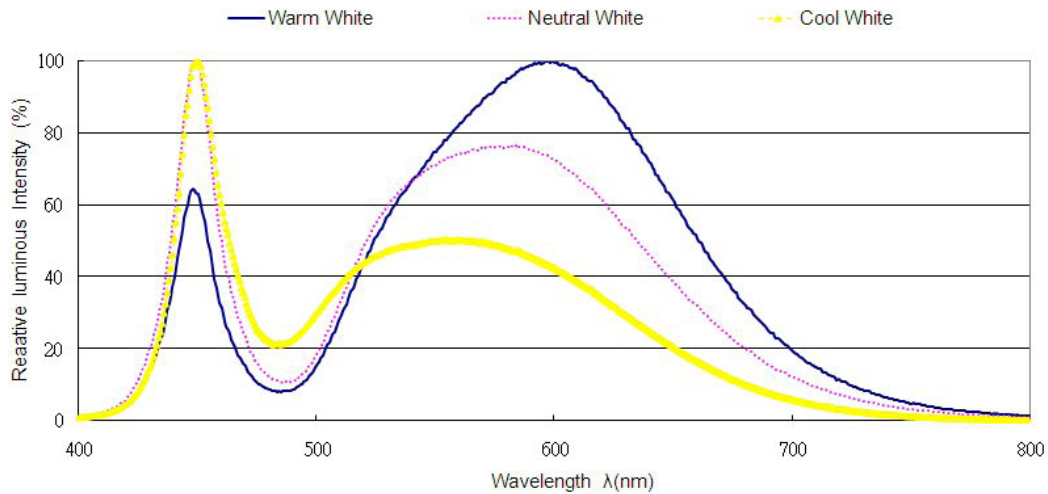


Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Luminous Flux	Φ		2808		lm	$I_f = 700\text{mA}$
Forward Voltage	V_F	35.4		39.6	V	$I_f = 700\text{mA}$
CRI	Ra	70	80	95		$I_f = 700\text{mA}$
Viewing Angle	2 θ 1/2	----	140	----	deg	$I_f = 700\text{mA}$
Reverse Current	I_R	----	----	50	μA	$V_r = 5\text{V}$

Notes:

1. Tolerance of Luminous flux: $\pm 11\%$.
2. Tolerance of Forward Voltage: $\pm 0.1\text{V}$.
3. Tolerance of Colour Rendering Index: ± 2

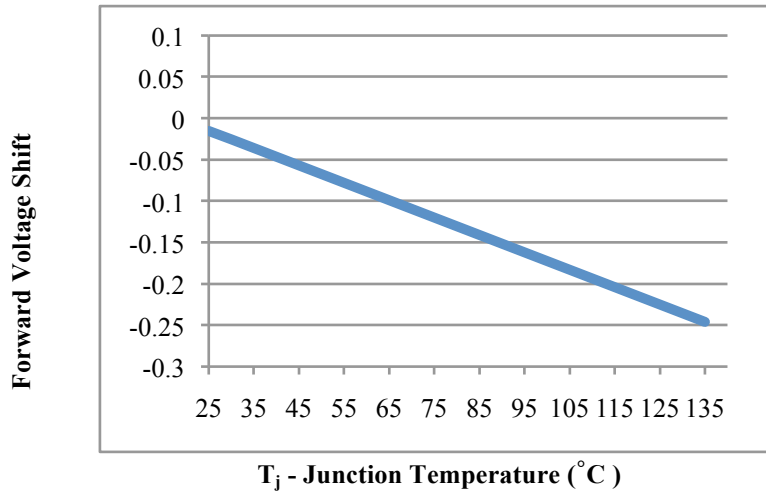
Spectrum Distribution



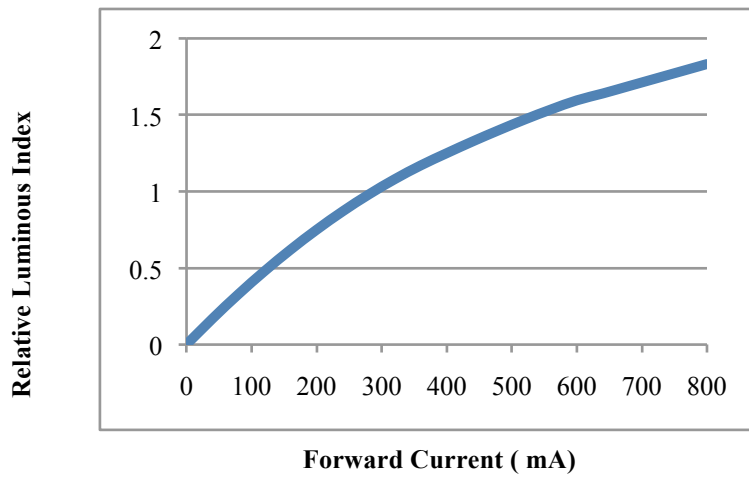
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Forward Voltage Shift vs Junction Temperature



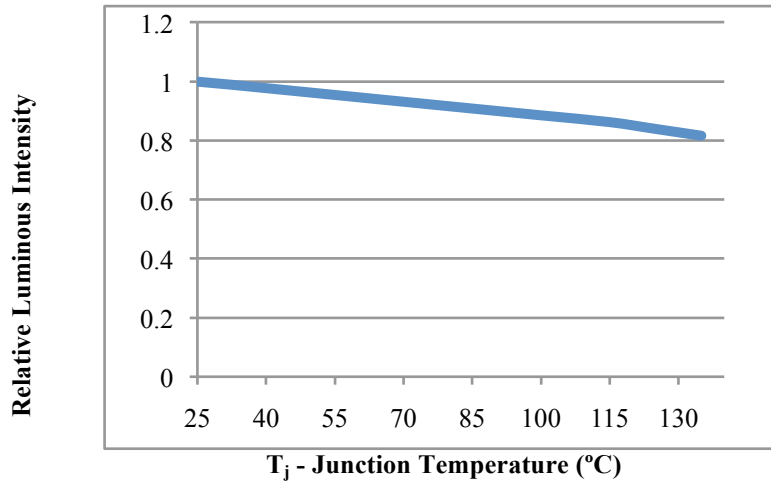
Relative Luminous Intensity vs Forward Current



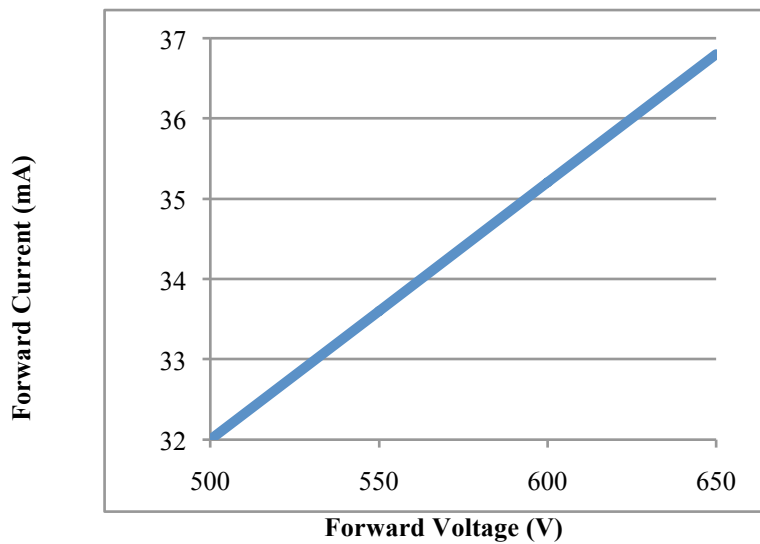
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Relative Luminous Intensity vs Junction Temperature



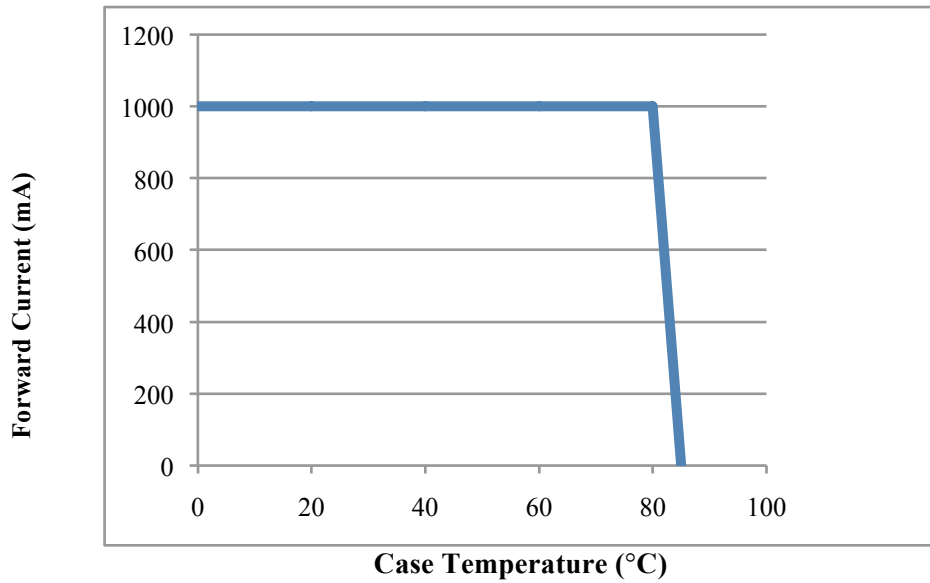
Forward Current vs. Forward Voltage



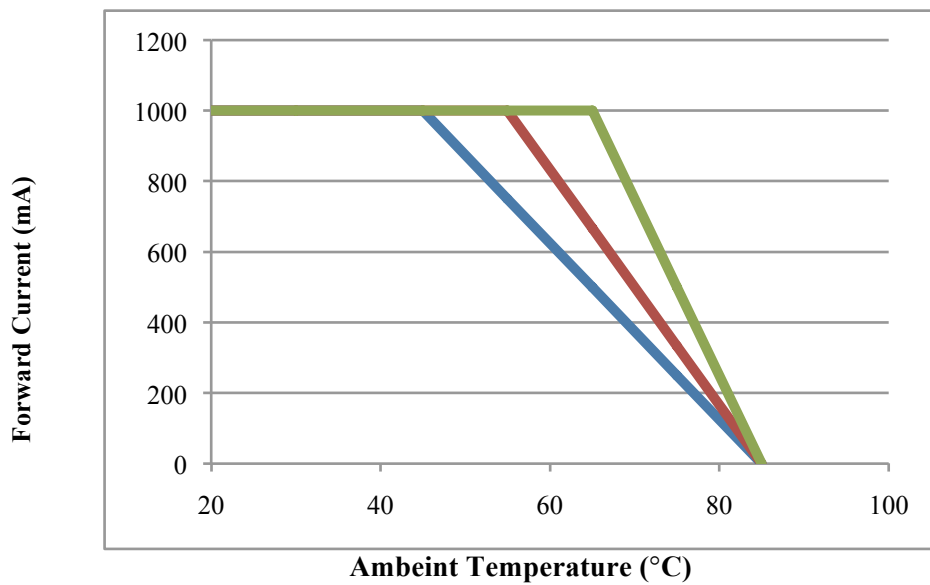
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Max Driving Forward Current vs Soldering Temperature



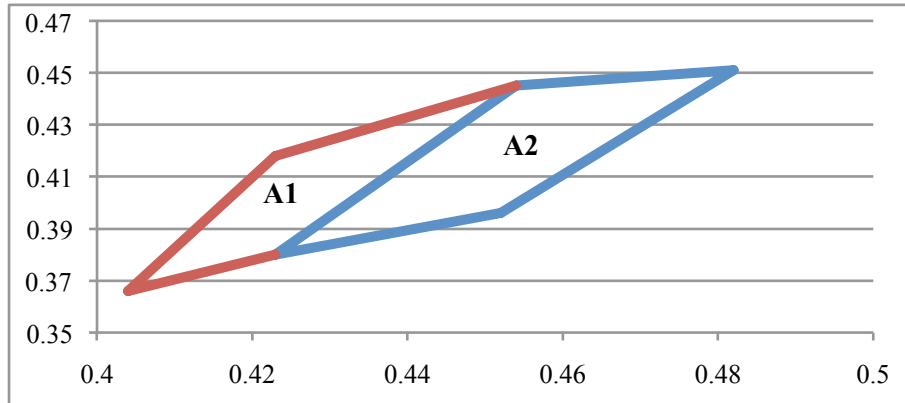
Max Driving Forward Current vs Ambient Temperature



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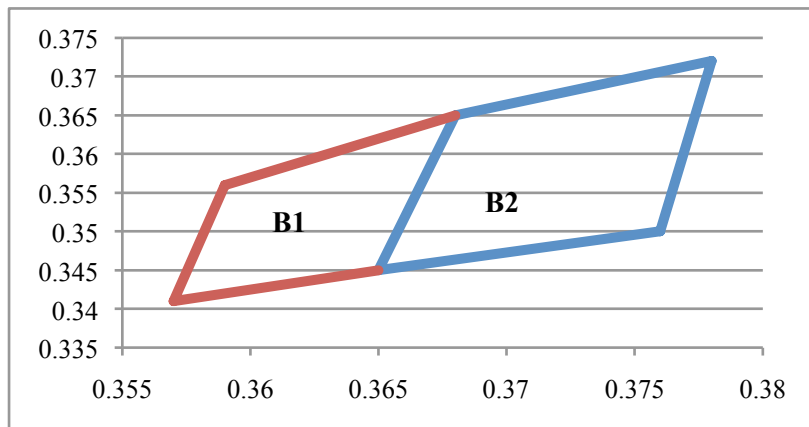


CCT – BIN FOR WARM WHITE LIGHT



BIN A 1	2700 – 3000K
BIN A 2	3000 – 3300K
BIN A 3	3300 – 3600K
BIN A 4	3600 – 3900K

CCT – BIN FOR NATURAL WHITE

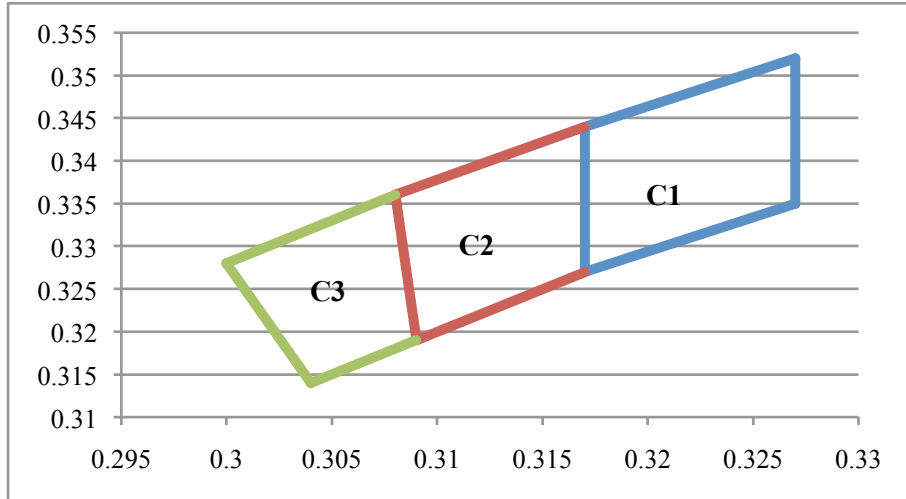


BIN B 1	3900 – 4200K
BIN B 2	4200 – 4500K
BIN B 3	4500 – 4800K
BIN B 4	4800 – 5300K
BIN B 5	5300 – 5800K

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CCT – BIN FOR COOL WHITE

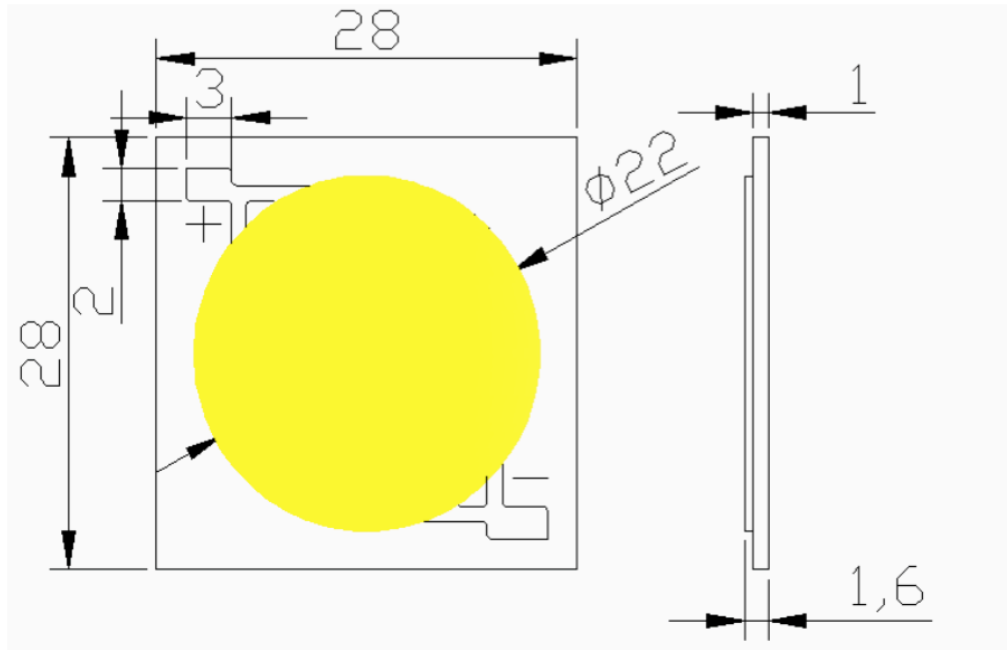


BIN C 1	5800 – 6200K
BIN C 2	6200 – 6600K
BIN C 3	6600 – 7000K
BIN C 4	7000 – 7500K

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Package Dimension



Note:

Tolerance unless mentioned is ± 0.15 mm ; Unit = mm

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Notes for Hand Soldering

- Hand Soldering Parameters - 300°C for not more than 3 seconds
- Hand Soldering shouldn't be done more than once.
- Avoid using sharp objects for compressing LEDs
- Use of anti-static apparels while operating on LED Chips is recommended

Storage

Before opening vacuum packing

- LEDs can be stored for one year under temperature and humidity not exceeding 30°C and 60% RH.

After opening vacuum packing

- The LED's floor life is 168 Hrs under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.